



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 158500  |
| Number of Logic Elements/Cells | 420000  |
| Total RAM Bits                 | 37888000  |
| Number of I/O                  | 600   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.87V ~ 0.93V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 1517-BBGA, FCBGA  |
| Supplier Device Package        | 1517-FBGA (40x40)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxma4k2f40c1n">https://www.e-xfl.com/product-detail/intel/5sgxma4k2f40c1n</a> |

**Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering <sup>(1), (2), (3)</sup> (Part 2 of 2)**

| Transceiver Speed Grade  | Core Speed Grade |         |     |     |         |         |                    |     |
|--------------------------|------------------|---------|-----|-----|---------|---------|--------------------|-----|
|                          | C1               | C2, C2L | C3  | C4  | I2, I2L | I3, I3L | I3YY               | I4  |
| 3<br>GX channel—8.5 Gbps | —                | Yes     | Yes | Yes | —       | Yes     | Yes <sup>(4)</sup> | Yes |

**Notes to Table 1:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.  
 (3) C2L, I2L, and I3L speed grades are for low-power devices.  
 (4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices.

**Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering <sup>(1), (2)</sup>**

| Transceiver Speed Grade                            | Core Speed Grade |     |     |     |
|--|------------------|-----|-----|-----|
|  | C1               | C2  | I2  | I3  |
| 2<br>GX channel—12.5 Gbps<br>GT channel—28.05 Gbps | Yes              | Yes | —   | —   |
| 3<br>GX channel—12.5 Gbps<br>GT channel—25.78 Gbps | Yes              | Yes | Yes | Yes |

**Notes to Table 2:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.

**Absolute Maximum Ratings**

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

**Table 3. Absolute Maximum Ratings for Stratix V Devices (Part 1 of 2)**

| Symbol              | Description  | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V <sub>CC</sub>     | Power supply for core voltage and periphery circuitry                  | −0.5    | 1.35    | V    |
| V <sub>CCPT</sub>   | Power supply for programmable power technology                         | −0.5    | 1.8     | V    |
| V <sub>CCPGM</sub>  | Power supply for configuration pins                                    | −0.5    | 3.9     | V    |
| V <sub>CC_AUX</sub> | Auxiliary supply for the programmable power technology                 | −0.5    | 3.4     | V    |
| V <sub>CCBAT</sub>  | Battery back-up power supply for design security volatile key register | −0.5    | 3.9     | V    |
| V <sub>CCPD</sub>   | I/O pre-driver power supply  | −0.5    | 3.9     | V    |
| V <sub>CCIO</sub>   | I/O power supply   | −0.5    | 3.9     | V    |

## Recommended Operating Conditions

This section lists the functional operating limits for the AC and DC parameters for Stratix V devices. Table 6 lists the steady-state voltage and current values expected from Stratix V devices. Power supply ramps must all be strictly monotonic, without plateaus.

**Table 6. Recommended Operating Conditions for Stratix V Devices (Part 1 of 2)**

| Symbol                            | Description   | Condition  | Min <sup>(4)</sup> | Typ  | Max <sup>(4)</sup> | Unit |
|-----------------------------------|---|------------|--------------------|------|--------------------|------|
| V <sub>CC</sub>                   | Core voltage and periphery circuitry power supply (C1, C2, I2, and I3YY speed grades)                             | —          | 0.87               | 0.9  | 0.93               | V    |
|                                   | Core voltage and periphery circuitry power supply (C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) <sup>(3)</sup> | —          | 0.82               | 0.85 | 0.88               | V    |
| V <sub>CCPT</sub>                 | Power supply for programmable power technology  | —          | 1.45               | 1.50 | 1.55               | V    |
| V <sub>CC_AUX</sub>               | Auxiliary supply for the programmable power technology  | —          | 2.375              | 2.5  | 2.625              | V    |
| V <sub>CCPD</sub> <sup>(1)</sup>  | I/O pre-driver (3.0 V) power supply   | —          | 2.85               | 3.0  | 3.15               | V    |
|                                   | I/O pre-driver (2.5 V) power supply   | —          | 2.375              | 2.5  | 2.625              | V    |
| V <sub>CCIO</sub>                 | I/O buffers (3.0 V) power supply  | —          | 2.85               | 3.0  | 3.15               | V    |
|                                   | I/O buffers (2.5 V) power supply  | —          | 2.375              | 2.5  | 2.625              | V    |
|                                   | I/O buffers (1.8 V) power supply  | —          | 1.71               | 1.8  | 1.89               | V    |
|                                   | I/O buffers (1.5 V) power supply  | —          | 1.425              | 1.5  | 1.575              | V    |
|                                   | I/O buffers (1.35 V) power supply   | —          | 1.283              | 1.35 | 1.45               | V    |
|                                   | I/O buffers (1.25 V) power supply   | —          | 1.19               | 1.25 | 1.31               | V    |
|                                   | I/O buffers (1.2 V) power supply  | —          | 1.14               | 1.2  | 1.26               | V    |
| V <sub>CCPGM</sub>                | Configuration pins (3.0 V) power supply   | —          | 2.85               | 3.0  | 3.15               | V    |
|                                   | Configuration pins (2.5 V) power supply   | —          | 2.375              | 2.5  | 2.625              | V    |
|                                   | Configuration pins (1.8 V) power supply   | —          | 1.71               | 1.8  | 1.89               | V    |
| V <sub>CCA_FPLL</sub>             | PLL analog voltage regulator power supply   | —          | 2.375              | 2.5  | 2.625              | V    |
| V <sub>CCD_FPLL</sub>             | PLL digital voltage regulator power supply  | —          | 1.45               | 1.5  | 1.55               | V    |
| V <sub>CCBAT</sub> <sup>(2)</sup> | Battery back-up power supply (For design security volatile key register)  | —          | 1.2                | —    | 3.0                | V    |
| V <sub>I</sub>                    | DC input voltage  | —          | −0.5               | —    | 3.6                | V    |
| V <sub>O</sub>                    | Output voltage  | —          | 0                  | —    | V <sub>CCIO</sub>  | V    |
| T <sub>J</sub>                    | Operating junction temperature  | Commercial | 0                  | —    | 85                 | °C   |
|                                   |   | Industrial | −40                | —    | 100                | °C   |

**Table 6. Recommended Operating Conditions for Stratix V Devices (Part 2 of 2)**

| Symbol            | Description            | Condition    | Min <sup>(4)</sup> | Typ | Max <sup>(4)</sup> | Unit |
|-------------------|------------------------|--------------|--------------------|-----|--------------------|------|
| t <sub>RAMP</sub> | Power supply ramp time | Standard POR | 200 $\mu$ s        | —   | 100 ms             | —    |
|                   |                        | Fast POR     | 200 $\mu$ s        | —   | 4 ms               | —    |

**Notes to Table 6:**

- (1) V<sub>CCPD</sub> must be 2.5 V when V<sub>CCIO</sub> is 2.5, 1.8, 1.5, 1.35, 1.25 or 1.2 V. V<sub>CCPD</sub> must be 3.0 V when V<sub>CCIO</sub> is 3.0 V.
- (2) If you do not use the design security feature in Stratix V devices, connect V<sub>CCBAT</sub> to a 1.2- to 3.0-V power supply. Stratix V power-on-reset (POR) circuitry monitors V<sub>CCBAT</sub>. Stratix V devices will not exit POR if V<sub>CCBAT</sub> stays at logic low.
- (3) C2L and I2L can also be run at 0.90 V for legacy boards that were designed for the C2 and I2 speed grades.
- (4) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 7 lists the transceiver power supply recommended operating conditions for Stratix V GX, GS, and GT devices.

**Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 1 of 2)**

| Symbol                            | Description   | Devices    | Minimum <sup>(4)</sup> | Typical | Maximum <sup>(4)</sup> | Unit |
|-----------------------------------|---|------------|------------------------|---------|------------------------|------|
| V <sub>CCA_GXBL</sub><br>(1), (3) | Transceiver channel PLL power supply (left side)  | GX, GS, GT | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GXBR</sub><br>(1), (3) | Transceiver channel PLL power supply (right side)   | GX, GS     | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GTBR</sub>             | Transceiver channel PLL power supply (right side)   | GT         | 2.85                   | 3.0     | 3.15                   | V    |
| V <sub>CCHIP_L</sub>              | Transceiver hard IP power supply (left side; C1, C2, I2, and I3YY speed grades)               | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHIP_R</sub>              | Transceiver hard IP power supply (right side; C1, C2, I2, and I3YY speed grades)              | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_L</sub>             | Transceiver PCS power supply (left side; C1, C2, I2, and I3YY speed grades)                   | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)      | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_R</sub>             | Transceiver PCS power supply (right side; C1, C2, I2, and I3YY speed grades)                  | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)     | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCR_GXBL</sub><br>(2)      | Receiver analog power supply (left side)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                                   |   |            | 0.87                   | 0.90    | 0.93                   |      |
|                                   |   |            | 0.97                   | 1.0     | 1.03                   |      |
|                                   |   |            | 1.03                   | 1.05    | 1.07                   |      |

Table 8 shows the transceiver power supply voltage requirements for various conditions.

**Table 8. Transceiver Power Supply Voltage Requirements**

| Conditions  | Core Speed Grade                  | VCCR_GXB & VCCT_GXB <sup>(2)</sup> | VCCA_GXB | VCCH_GXB | Unit |
|---|-----------------------------------|------------------------------------|----------|----------|------|
| If BOTH of the following conditions are true:<br><ul style="list-style-type: none"> <li>■ Data rate &gt; 10.3 Gbps.</li> <li>■ DFE is used.</li> </ul>  | All                               | 1.05                               | 3.0      | 1.5      | V    |
| If ANY of the following conditions are true <sup>(1)</sup> :<br><ul style="list-style-type: none"> <li>■ ATX PLL is used.</li> <li>■ Data rate &gt; 6.5Gbps.</li> <li>■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used.</li> </ul> | All                               | 1.0                                |          |          |      |
| If ALL of the following conditions are true:<br><ul style="list-style-type: none"> <li>■ ATX PLL is not used.</li> <li>■ Data rate ≤ 6.5Gbps.</li> <li>■ DFE, AEQ, and EyeQ are not used.</li> </ul>  | C1, C2, I2, and I3YY              | 0.90                               | 2.5      |          |      |
|   | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85                               | 2.5      |          |      |

**Notes to Table 8:**

- (1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.
- (2) If the VCCR\_GXB and VCCT\_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR\_GXB and VCCT\_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

## DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

### Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.



For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

**Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 2 of 2)**

| I/O Standard        | $V_{CCIO}$ (V) |     |      | $V_{DIF(DC)}$ (V) |                  | $V_{X(AC)}$ (V)         |                  |                         | $V_{CM(DC)}$ (V) |                  |                  | $V_{DIF(AC)}$ (V) |                   |
|---------------------|----------------|-----|------|-------------------|------------------|-------------------------|------------------|-------------------------|------------------|------------------|------------------|-------------------|-------------------|
|                     | Min            | Typ | Max  | Min               | Max              | Min                     | Typ              | Max                     | Min              | Typ              | Max              | Min               | Max               |
| HSTL-12 Class I, II | 1.14           | 1.2 | 1.26 | 0.16              | $V_{CCIO} + 0.3$ | —                       | $0.5^* V_{CCIO}$ | —                       | $0.4^* V_{CCIO}$ | $0.5^* V_{CCIO}$ | $0.6^* V_{CCIO}$ | 0.3               | $V_{CCIO} + 0.48$ |
| HSUL-12             | 1.14           | 1.2 | 1.3  | 0.26              | 0.26             | $0.5^* V_{CCIO} - 0.12$ | $0.5^* V_{CCIO}$ | $0.5^* V_{CCIO} + 0.12$ | $0.4^* V_{CCIO}$ | $0.5^* V_{CCIO}$ | $0.6^* V_{CCIO}$ | 0.44              | 0.44              |

**Table 22. Differential I/O Standard Specifications for Stratix V Devices <sup>(7)</sup>**

| I/O Standard                   | $V_{CCIO}$ (V) <sup>(10)</sup>   |     |       | $V_{ID}$ (mV) <sup>(8)</sup> |                   |     | $V_{ICM(DC)}$ (V) |                         |       | $V_{OD}$ (V) <sup>(6)</sup> |     |     | $V_{OCM}$ (V) <sup>(6)</sup> |      |       |
|--------------------------------|--|-----|-------|------------------------------|-------------------|-----|-------------------|-------------------------|-------|-----------------------------|-----|-----|------------------------------|------|-------|
|                                | Min  | Typ | Max   | Min                          | Condition         | Max | Min               | Condition               | Max   | Min                         | Typ | Max | Min                          | Typ  | Max   |
| PCML                           | Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Table 23 on page 18. |     |       |                              |                   |     |                   |                         |       |                             |     |     |                              |      |       |
| 2.5 V LVDS <sup>(1)</sup>      | 2.375  | 2.5 | 2.625 | 100                          | $V_{CM} = 1.25$ V | —   | 0.05              | $D_{MAX} \leq 700$ Mbps | 1.8   | 0.247                       | —   | 0.6 | 1.125                        | 1.25 | 1.375 |
|                                |  |     |       |                              |                   | —   | 1.05              | $D_{MAX} > 700$ Mbps    | 1.55  | 0.247                       | —   | 0.6 | 1.125                        | 1.25 | 1.375 |
| BLVDS <sup>(5)</sup>           | 2.375  | 2.5 | 2.625 | 100                          | —                 | —   | —                 | —                       | —     | —                           | —   | —   | —                            | —    | —     |
| RSDS (HIO) <sup>(2)</sup>      | 2.375  | 2.5 | 2.625 | 100                          | $V_{CM} = 1.25$ V | —   | 0.3               | —                       | 1.4   | 0.1                         | 0.2 | 0.6 | 0.5                          | 1.2  | 1.4   |
| Mini-LVDS (HIO) <sup>(3)</sup> | 2.375  | 2.5 | 2.625 | 200                          | —                 | 600 | 0.4               | —                       | 1.325 | 0.25                        | —   | 0.6 | 1                            | 1.2  | 1.4   |
| LVPECL <sup>(4), (9)</sup>     | —  | —   | —     | 300                          | —                 | —   | 0.6               | $D_{MAX} \leq 700$ Mbps | 1.8   | —                           | —   | —   | —                            | —    | —     |
|                                | —  | —   | —     | 300                          | —                 | —   | 1                 | $D_{MAX} > 700$ Mbps    | 1.6   | —                           | —   | —   | —                            | —    | —     |

**Notes to Table 22:**

- (1) For optimized LVDS receiver performance, the receiver voltage input range must be between 1.0 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.
- (2) For optimized RSDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.45 V.
- (3) For optimized Mini-LVDS receiver performance, the receiver voltage input range must be between 0.3 V to 1.425 V.
- (4) For optimized LVPECL receiver performance, the receiver voltage input range must be between 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.
- (5) There are no fixed  $V_{ICM}$ ,  $V_{OD}$ , and  $V_{OCM}$  specifications for BLVDS. They depend on the system topology.
- (6) RL range:  $90 \leq RL \leq 110 \Omega$ .
- (7) The 1.4-V and 1.5-V PCML transceiver I/O standard specifications are described in "Transceiver Performance Specifications" on page 18.
- (8) The minimum VID value is applicable over the entire common mode range, VCM.
- (9) LVPECL is only supported on dedicated clock input pins.
- (10) Differential inputs are powered by VCCPD which requires 2.5 V.

## Power Consumption

Altera offers two ways to estimate power consumption for a design—the Excel-based Early Power Estimator and the Quartus® II PowerPlay Power Analyzer feature.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 3 of 7)**

| Symbol/<br>Description  | Conditions   | Transceiver Speed<br>Grade 1                         |     |       | Transceiver Speed<br>Grade 2 |     |       | Transceiver Speed<br>Grade 3 |     |                                     | Unit |
|---|--|--|-----|-------|------------------------------|-----|-------|------------------------------|-----|-------------------------------------|------|
|   |  | Min  | Typ | Max   | Min                          | Typ | Max   | Min                          | Typ | Max                                 |      |
| Reconfiguration clock<br>( <code>mgmt_clk_clk</code> )<br>frequency   | —  | 100  | —   | 125   | 100                          | —   | 125   | 100                          | —   | 125                                 | MHz  |
| <b>Receiver</b>   |  |  |     |       |                              |     |       |                              |     |                                     |      |
| Supported I/O Standards   | —  | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS |     |       |                              |     |       |                              |     |                                     |      |
| Data rate<br>(Standard PCS)<br><sup>(9), (23)</sup>   | —  | 600  | —   | 12200 | 600                          | —   | 12200 | 600                          | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
| Data rate<br>(10G PCS) <sup>(9), (23)</sup>   | —  | 600  | —   | 14100 | 600                          | —   | 12500 | 600                          | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
| Absolute $V_{MAX}$ for<br>a receiver pin <sup>(5)</sup>   | —  | —  | —   | 1.2   | —                            | —   | 1.2   | —                            | —   | 1.2                                 | V    |
| Absolute $V_{MIN}$ for<br>a receiver pin  | —  | −0.4   | —   | —     | −0.4                         | —   | —     | −0.4                         | —   | —                                   | V    |
| Maximum peak-<br>to-peak<br>differential input<br>voltage $V_{ID}$ (diff p-<br>p) before device<br>configuration <sup>(22)</sup>      | —  | —  | —   | 1.6   | —                            | —   | 1.6   | —                            | —   | 1.6                                 | V    |
| Maximum peak-<br>to-peak<br>differential input<br>voltage $V_{ID}$ (diff p-<br>p) after device<br>configuration <sup>(18), (22)</sup> | $V_{CCR\_GXB} =$<br>1.0 V/1.05 V<br>( $V_{ICM} =$<br>0.70 V) | —  | —   | 2.0   | —                            | —   | 2.0   | —                            | —   | 2.0                                 | V    |
|   | $V_{CCR\_GXB} =$<br>0.90 V<br>( $V_{ICM} = 0.6$ V)           | —  | —   | 2.4   | —                            | —   | 2.4   | —                            | —   | 2.4                                 | V    |
|   | $V_{CCR\_GXB} =$<br>0.85 V<br>( $V_{ICM} = 0.6$ V)           | —  | —   | 2.4   | —                            | —   | 2.4   | —                            | —   | 2.4                                 | V    |
| Minimum<br>differential eye<br>opening at<br>receiver serial<br>input pins <sup>(6), (22), (27)</sup>                                 | —  | 85   | —   | —     | 85                           | —   | —     | 85                           | —   | —                                   | mV   |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 4 of 7)**

| Symbol/<br>Description                                     | Conditions  | Transceiver Speed<br>Grade 1 |               |     | Transceiver Speed<br>Grade 2 |               |     | Transceiver Speed<br>Grade 3 |               |     | Unit     |
|--|---|------------------------------|---------------|-----|------------------------------|---------------|-----|------------------------------|---------------|-----|----------|
|  |   | Min                          | Typ           | Max | Min                          | Typ           | Max | Min                          | Typ           | Max |          |
| Differential on-chip termination resistors <sup>(21)</sup> | 85- $\Omega$ setting                                    | —                            | 85 $\pm$ 30%  | —   | —                            | 85 $\pm$ 30%  | —   | —                            | 85 $\pm$ 30%  | —   | $\Omega$ |
|  | 100- $\Omega$ setting                                   | —                            | 100 $\pm$ 30% | —   | —                            | 100 $\pm$ 30% | —   | —                            | 100 $\pm$ 30% | —   | $\Omega$ |
|  | 120- $\Omega$ setting                                   | —                            | 120 $\pm$ 30% | —   | —                            | 120 $\pm$ 30% | —   | —                            | 120 $\pm$ 30% | —   | $\Omega$ |
|  | 150- $\Omega$ setting                                   | —                            | 150 $\pm$ 30% | —   | —                            | 150 $\pm$ 30% | —   | —                            | 150 $\pm$ 30% | —   | $\Omega$ |
| V <sub>ICM</sub><br>(AC and DC coupled)                    | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V full bandwidth   | —                            | 600           | —   | —                            | 600           | —   | —                            | 600           | —   | mV       |
|  | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V half bandwidth   | —                            | 600           | —   | —                            | 600           | —   | —                            | 600           | —   | mV       |
|  | V <sub>CCR_GXB</sub> = 1.0 V/1.05 V full bandwidth      | —                            | 700           | —   | —                            | 700           | —   | —                            | 700           | —   | mV       |
|  | V <sub>CCR_GXB</sub> = 1.0 V half bandwidth             | —                            | 750           | —   | —                            | 750           | —   | —                            | 750           | —   | mV       |
| t <sub>LTR</sub> <sup>(11)</sup>                           | —   | —                            | —             | 10  | —                            | —             | 10  | —                            | —             | 10  | $\mu$ s  |
| t <sub>LTD</sub> <sup>(12)</sup>                           | —   | 4                            | —             | —   | 4                            | —             | —   | 4                            | —             | —   | $\mu$ s  |
| t <sub>LTD_manual</sub> <sup>(13)</sup>                    | —   | 4                            | —             | —   | 4                            | —             | —   | 4                            | —             | —   | $\mu$ s  |
| t <sub>LTR_LTD_manual</sub> <sup>(14)</sup>                | —   | 15                           | —             | —   | 15                           | —             | —   | 15                           | —             | —   | $\mu$ s  |
| Run Length   | —   | —                            | —             | 200 | —                            | —             | 200 | —                            | —             | 200 | UI       |
| Programmable equalization (AC Gain) <sup>(10)</sup>        | Full bandwidth (6.25 GHz)<br>Half bandwidth (3.125 GHz) | —                            | —             | 16  | —                            | —             | 16  | —                            | —             | 16  | dB       |



## PLL Specifications

Table 31 lists the Stratix V PLL specifications when operating in both the commercial junction temperature range (0° to 85°C) and the industrial junction temperature range (–40° to 100°C).

**Table 31. PLL Specifications for Stratix V Devices (Part 1 of 3)**

| Symbol                   | Parameter  | Min | Typ | Max                | Unit |
|--------------------------|--|-----|-----|--------------------|------|
| $f_{IN}$                 | Input clock frequency (C1, C2, C2L, I2, and I2L speed grades)  | 5   | —   | 800 <sup>(1)</sup> | MHz  |
|                          | Input clock frequency (C3, I3, I3L, and I3YY speed grades)   | 5   | —   | 800 <sup>(1)</sup> | MHz  |
|                          | Input clock frequency (C4, I4 speed grades)  | 5   | —   | 650 <sup>(1)</sup> | MHz  |
| $f_{INPFD}$              | Input frequency to the PFD   | 5   | —   | 325                | MHz  |
| $f_{FINPFD}$             | Fractional Input clock frequency to the PFD  | 50  | —   | 160                | MHz  |
| $f_{VCO}$ <sup>(9)</sup> | PLL VCO operating range (C1, C2, C2L, I2, I2L speed grades)  | 600 | —   | 1600               | MHz  |
|                          | PLL VCO operating range (C3, I3, I3L, I3YY speed grades)   | 600 | —   | 1600               | MHz  |
|                          | PLL VCO operating range (C4, I4 speed grades)  | 600 | —   | 1300               | MHz  |
| $t_{EINDUTY}$            | Input clock or external feedback clock input duty cycle  | 40  | —   | 60                 | %    |
| $f_{OUT}$                | Output frequency for an internal global or regional clock (C1, C2, C2L, I2, I2L speed grades)            | —   | —   | 717 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an internal global or regional clock (C3, I3, I3L speed grades)                     | —   | —   | 650 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an internal global or regional clock (C4, I4 speed grades)                          | —   | —   | 580 <sup>(2)</sup> | MHz  |
| $f_{OUT\_EXT}$           | Output frequency for an external clock output (C1, C2, C2L, I2, I2L speed grades)                        | —   | —   | 800 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an external clock output (C3, I3, I3L speed grades)                                 | —   | —   | 667 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an external clock output (C4, I4 speed grades)                                      | —   | —   | 553 <sup>(2)</sup> | MHz  |
| $t_{OUTDUTY}$            | Duty cycle for a dedicated external clock output (when set to 50%)                                       | 45  | 50  | 55                 | %    |
| $t_{FCOMP}$              | External feedback clock compensation time  | —   | —   | 10                 | ns   |
| $f_{DYCONFIGCLK}$        | Dynamic Configuration Clock used for <code>mgmt_clk</code> and <code>scanclk</code>                      | —   | —   | 100                | MHz  |
| $t_{LOCK}$               | Time required to lock from the end-of-device configuration or deassertion of <code>areset</code>         | —   | —   | 1                  | ms   |
| $t_{DLOCK}$              | Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays) | —   | —   | 1                  | ms   |
| $f_{CLBW}$               | PLL closed-loop low bandwidth  | —   | 0.3 | —                  | MHz  |
|                          | PLL closed-loop medium bandwidth   | —   | 1.5 | —                  | MHz  |
|                          | PLL closed-loop high bandwidth <sup>(7)</sup>  | —   | 4   | —                  | MHz  |
| $t_{PLL\_PSERR}$         | Accuracy of PLL phase shift  | —   | —   | ±50                | ps   |
| $t_{ARESET}$             | Minimum pulse width on the <code>areset</code> signal  | 10  | —   | —                  | ns   |

**Table 33. Memory Block Performance Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Memory     | Mode   | Resources Used |        | Performance |         |     |     |         |               |     | Unit |
|------------|--|----------------|--------|-------------|---------|-----|-----|---------|---------------|-----|------|
|            |  | ALUTs          | Memory | C1          | C2, C2L | C3  | C4  | I2, I2L | I3, I3L, I3YY | I4  |      |
| M20K Block | Single-port, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port with the read-during-write option set to <b>Old Data</b> , all supported widths | 0              | 1      | 525         | 525     | 455 | 400 | 525     | 455           | 400 | MHz  |
|            | Simple dual-port with ECC enabled, 512 × 32  | 0              | 1      | 450         | 450     | 400 | 350 | 450     | 400           | 350 | MHz  |
|            | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32                      | 0              | 1      | 600         | 600     | 500 | 450 | 600     | 500           | 450 | MHz  |
|            | True dual port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | ROM, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |

**Notes to Table 33:**

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in  $F_{MAX}$ .
- (3) The  $F_{MAX}$  specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.

**Temperature Sensing Diode Specifications**

Table 34 lists the internal TSD specification.

**Table 34. Internal Temperature Sensing Diode Specification**

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate  | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|-------------------|----------|--------------------------|----------------|-----------------|------------|--|
| –40°C to 100°C    | ±8°C     | No                       | 1 MHz, 500 KHz | < 100 ms        | 8 bits     | 8 bits                                   |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

**Table 35. External Temperature Sensing Diode Specifications for Stratix V Devices**

| Description                       | Min   | Typ   | Max   | Unit |
|-----------------------------------|-------|-------|-------|------|
| $I_{bias}$ , diode source current | 8     | —     | 200   | μA   |
| $V_{bias}$ , voltage across diode | 0.3   | —     | 0.9   | V    |
| Series resistance                 | —     | —     | < 1   | Ω    |
| Diode ideality factor             | 1.006 | 1.008 | 1.010 | —    |

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 4)**

| Symbol   | Conditions  | C1  |     |      | C2, C2L, I2, I2L |     |      | C3, I3, I3L, I3YY |     |      | C4,I4 |     |      | Unit |
|--|---|-----|-----|------|------------------|-----|------|-------------------|-----|------|-------|-----|------|------|
|  |   | Min | Typ | Max  | Min              | Typ | Max  | Min               | Typ | Max  | Min   | Typ | Max  |      |
| Transmitter  |   |     |     |      |                  |     |      |                   |     |      |       |     |      |      |
| True Differential I/O Standards - f <sub>HSDR</sub> (data rate)  | SERDES factor J = 3 to 10 <sup>(9), (11), (12), (13), (14), (15), (16)</sup>  | (6) | —   | 1600 | (6)              | —   | 1434 | (6)               | —   | 1250 | (6)   | —   | 1050 | Mbps |
|  | SERDES factor J ≥ 4<br><br>LVDS TX with DPA <sup>(12), (14), (15), (16)</sup> | (6) | —   | 1600 | (6)              | —   | 1600 | (6)               | —   | 1600 | (6)   | —   | 1250 | Mbps |
|  | SERDES factor J = 2,<br>uses DDR Registers                                    | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
|  | SERDES factor J = 1,<br>uses SDR Register                                     | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f <sub>HSDR</sub> (data rate) <sup>(10)</sup> | SERDES factor J = 4 to 10 <sup>(17)</sup>                                     | (6) | —   | 1100 | (6)              | —   | 1100 | (6)               | —   | 840  | (6)   | —   | 840  | Mbps |
| t <sub>x Jitter</sub> - True Differential I/O Standards  | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 160  | —                | —   | 160  | —                 | —   | 160  | —     | —   | 160  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.1  | —                | —   | 0.1  | —                 | —   | 0.1  | —     | —   | 0.1  | UI   |
| t <sub>x Jitter</sub> - Emulated Differential I/O Standards with Three External Output Resistor Network                          | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 300  | —                | —   | 300  | —                 | —   | 300  | —     | —   | 325  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.2  | —                | —   | 0.2  | —                 | —   | 0.2  | —     | —   | 0.25 | UI   |

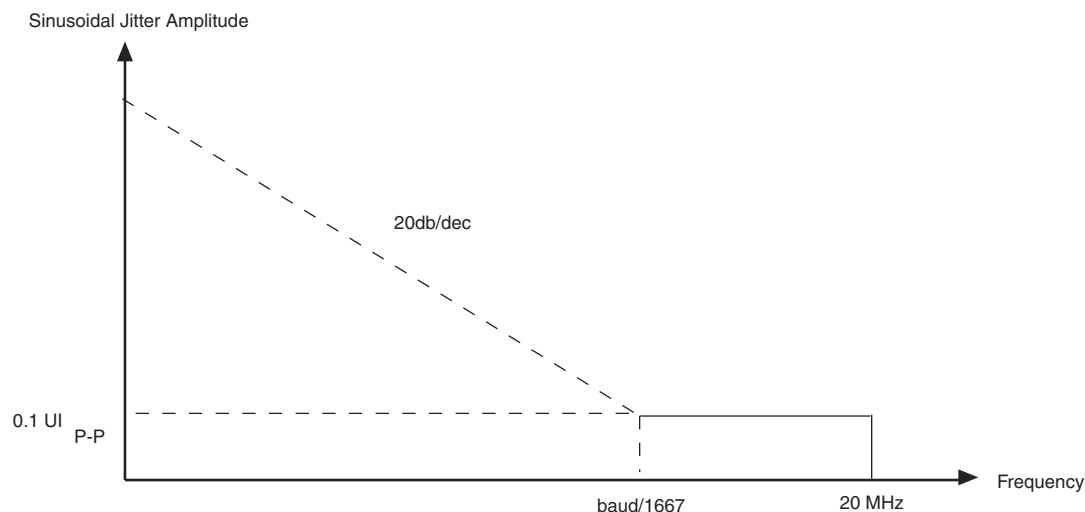
**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 3 of 4)**

| Symbol   | Conditions  | C1             |     |                | C2, C2L, I2, I2L |     |                | C3, I3, I3L, I3YY |     |                | C4, I4         |     |                | Unit |
|--|---|----------------|-----|----------------|------------------|-----|----------------|-------------------|-----|----------------|----------------|-----|----------------|------|
|  |   | Min            | Typ | Max            | Min              | Typ | Max            | Min               | Typ | Max            | Min            | Typ | Max            |      |
| $t_{DUTY}$   | Transmitter output clock duty cycle for both True and Emulated Differential I/O Standards   | 45             | 50  | 55             | 45               | 50  | 55             | 45                | 50  | 55             | 45             | 50  | 55             | %    |
| $t_{RISE}$ & $t_{FALL}$                                    | True Differential I/O Standards   | —              | —   | 160            | —                | —   | 160            | —                 | —   | 200            | —              | —   | 200            | ps   |
|  | Emulated Differential I/O Standards with three external output resistor networks  | —              | —   | 250            | —                | —   | 250            | —                 | —   | 250            | —              | —   | 300            | ps   |
| TCCS   | True Differential I/O Standards   | —              | —   | 150            | —                | —   | 150            | —                 | —   | 150            | —              | —   | 150            | ps   |
|  | Emulated Differential I/O Standards   | —              | —   | 300            | —                | —   | 300            | —                 | —   | 300            | —              | —   | 300            | ps   |
| <b>Receiver</b>  |   |                |     |                |                  |     |                |                   |     |                |                |     |                |      |
| True Differential I/O Standards - $f_{HSDRDP}$ (data rate) | SERDES factor J = 3 to 10 <sup>(11)</sup> , <sup>(12)</sup> , <sup>(13)</sup> , <sup>(14)</sup> , <sup>(15)</sup> , <sup>(16)</sup> | 150            | —   | 1434           | 150              | —   | 1434           | 150               | —   | 1250           | 150            | —   | 1050           | Mbps |
|  | SERDES factor J $\geq 4$  | 150            | —   | 1600           | 150              | —   | 1600           | 150               | —   | 1600           | 150            | —   | 1250           | Mbps |
|  | LVDS RX with DPA <sup>(12)</sup> , <sup>(14)</sup> , <sup>(15)</sup> , <sup>(16)</sup>  | 150            | —   | 1600           | 150              | —   | 1600           | 150               | —   | 1600           | 150            | —   | 1250           | Mbps |
|  | SERDES factor J = 2, uses DDR Registers   | <sup>(6)</sup> | —   | <sup>(7)</sup> | <sup>(6)</sup>   | —   | <sup>(7)</sup> | <sup>(6)</sup>    | —   | <sup>(7)</sup> | <sup>(6)</sup> | —   | <sup>(7)</sup> | Mbps |
|  | SERDES factor J = 1, uses SDR Register  | <sup>(6)</sup> | —   | <sup>(7)</sup> | <sup>(6)</sup>   | —   | <sup>(7)</sup> | <sup>(6)</sup>    | —   | <sup>(7)</sup> | <sup>(6)</sup> | —   | <sup>(7)</sup> | Mbps |

**Table 38. LVDS Soft-CDR/DPA Sinusoidal Jitter Mask Values for a Data Rate  $\geq 1.25$  Gbps**

| Jitter Frequency (Hz) |            | Sinusoidal Jitter (UI) |
|-----------------------|------------|------------------------|
| F1                    | 10,000     | 25.000                 |
| F2                    | 17,565     | 25.000                 |
| F3                    | 1,493,000  | 0.350                  |
| F4                    | 50,000,000 | 0.350                  |

Figure 9 shows the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate  $< 1.25$  Gbps.

**Figure 9. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate  $< 1.25$  Gbps**

### DLL Range, DQS Logic Block, and Memory Output Clock Jitter Specifications

Table 39 lists the DLL range specification for Stratix V devices. The DLL is always in 8-tap mode in Stratix V devices.

**Table 39. DLL Range Specifications for Stratix V Devices <sup>(1)</sup>**

| C1      | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4   | Unit |
|---------|------------------|-------------------|---------|------|
| 300-933 | 300-933          | 300-890           | 300-890 | MHz  |

**Note to Table 39:**

- (1) Stratix V devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Table 40 lists the DQS phase offset delay per stage for Stratix V devices.

**Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Speed Grade      | Min | Max | Unit |
|------------------|-----|-----|------|
| C1               | 8   | 14  | ps   |
| C2, C2L, I2, I2L | 8   | 14  | ps   |
| C3,I3, I3L, I3YY | 8   | 15  | ps   |

**Table 42. Memory Output Clock Jitter Specification for Stratix V Devices <sup>(1)</sup>, (Part 2 of 2) <sup>(2)</sup>, <sup>(3)</sup>**

| Clock Network | Parameter                    | Symbol          | C1    |      | C2, C2L, I2, I2L |      | C3, I3, I3L, I3YY |     | C4,I4 |     | Unit |
|---------------|------------------------------|-----------------|-------|------|------------------|------|-------------------|-----|-------|-----|------|
|               |                              |                 | Min   | Max  | Min              | Max  | Min               | Max | Min   | Max |      |
| PHY Clock     | Clock period jitter          | $t_{JIT(per)}$  | -25   | 25   | -25              | 25   | -30               | 30  | -35   | 35  | ps   |
|               | Cycle-to-cycle period jitter | $t_{JIT(cc)}$   | -50   | 50   | -50              | 50   | -60               | 60  | -70   | 70  | ps   |
|               | Duty cycle jitter            | $t_{JIT(duty)}$ | -37.5 | 37.5 | -37.5            | 37.5 | -45               | 45  | -56   | 56  | ps   |

**Notes to Table 42:**

- (1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.
- (2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.
- (3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

**OCT Calibration Block Specifications**

Table 43 lists the OCT calibration block specifications for Stratix V devices.

**Table 43. OCT Calibration Block Specifications for Stratix V Devices**

| Symbol         | Description   | Min | Typ  | Max | Unit   |
|----------------|---|-----|------|-----|--------|
| OCTUSRCLK      | Clock required by the OCT calibration blocks  | —   | —    | 20  | MHz    |
| $T_{OCTCAL}$   | Number of OCTUSRCLK clock cycles required for OCT $R_S/R_T$ calibration   | —   | 1000 | —   | Cycles |
| $T_{OCTSHIFT}$ | Number of OCTUSRCLK clock cycles required for the OCT code to shift out   | —   | 32   | —   | Cycles |
| $T_{RS\_RT}$   | Time required between the <code>dyn_term_ctrl</code> and <code>oe</code> signal transitions in a bidirectional I/O buffer to dynamically switch between OCT $R_S$ and $R_T$ (Figure 10) | —   | 2.5  | —   | ns     |

Figure 10 shows the timing diagram for the `oe` and `dyn_term_ctrl` signals.

**Figure 10. Timing Diagram for `oe` and `dyn_term_ctrl` Signals**

**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family                     | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) <sup>(4), (5)</sup> |
|----------------------------|--------|---------|--------------------------------|--|
| Stratix V E <sup>(1)</sup> | 5SEE9  | —       | 342,742,976                    | 700,888                                    |
|                            | 5SEEB  | —       | 342,742,976                    | 700,888                                    |

**Notes to Table 47:**

- (1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.
- (2) 36-transceiver devices.
- (3) 24-transceiver devices.
- (4) File size for the periphery image.
- (5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.tff) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.



For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices*. For creating configuration files, refer to the *Quartus II Help*.

Table 48 lists the minimum configuration time estimates for Stratix V devices.

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GX      | A3          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | A4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | A5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | AB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | B5          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B6          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | BB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
| GT      | C5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | C7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |

Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [ ] ratio is more than 1.

**Table 51. FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[ ] Ratio is >1 <sup>(1)</sup>**

| Symbol                     | Parameter   | Minimum   | Maximum              | Units   |
|----------------------------|---|---|----------------------|---------|
| $t_{CF2CD}$                | nCONFIG low to CONF_DONE low                      | —   | 600                  | ns      |
| $t_{CF2ST0}$               | nCONFIG low to nSTATUS low                        | —   | 600                  | ns      |
| $t_{CFG}$                  | nCONFIG low pulse width                           | 2   | —                    | $\mu$ s |
| $t_{STATUS}$               | nSTATUS low pulse width                           | 268   | 1,506 <sup>(2)</sup> | $\mu$ s |
| $t_{CF2ST1}$               | nCONFIG high to nSTATUS high                      | —   | 1,506 <sup>(2)</sup> | $\mu$ s |
| $t_{CF2CK}$ <sup>(5)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506   | —                    | $\mu$ s |
| $t_{ST2CK}$ <sup>(5)</sup> | nSTATUS high to first rising edge of DCLK         | 2   | —                    | $\mu$ s |
| $t_{DSU}$                  | DATA [ ] setup time before rising edge on DCLK    | 5.5   | —                    | ns      |
| $t_{DH}$                   | DATA [ ] hold time after rising edge on DCLK      | $N-1/f_{DCLK}$ <sup>(5)</sup>                                   | —                    | s       |
| $t_{CH}$                   | DCLK high time                                    | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CL}$                   | DCLK low time                                     | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CLK}$                  | DCLK period                                       | $1/f_{MAX}$   | —                    | s       |
| $f_{MAX}$                  | DCLK frequency (FPP $\times 8/\times 16$ )        | —   | 125                  | MHz     |
|                            | DCLK frequency (FPP $\times 32$ )                 | —   | 100                  | MHz     |
| $t_R$                      | Input rise time                                   | —   | 40                   | ns      |
| $t_F$                      | Input fall time                                   | —   | 40                   | ns      |
| $t_{CD2UM}$                | CONF_DONE high to user mode <sup>(3)</sup>        | 175   | 437                  | $\mu$ s |
| $t_{CD2CU}$                | CONF_DONE high to CLKUSR enabled                  | $4 \times$ maximum DCLK period                                  | —                    | —       |
| $t_{CD2UMC}$               | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})$ <sup>(4)</sup> | —                    | —       |

**Notes to Table 51:**

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (5) N is the DCLK-to-DATA ratio and  $f_{DCLK}$  is the DCLK frequency the system is operating.
- (6) If nSTATUS is monitored, follow the  $t_{ST2CK}$  specification. If nSTATUS is not monitored, follow the  $t_{CF2CK}$  specification.



## Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

**Table 52. DCLK Frequency Specification in the AS Configuration Scheme <sup>(1), (2)</sup>**

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3     | 7.9     | 12.5    | MHz  |
| 10.6    | 15.7    | 25.0    | MHz  |
| 21.3    | 31.4    | 50.0    | MHz  |
| 42.6    | 62.9    | 100.0   | MHz  |

**Notes to Table 52:**

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

**Figure 14. AS Configuration Timing**



**Notes to Figure 14:**

- (1) If you are using AS ×4 mode, this signal represents the AS\_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

**Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol   | Parameter                                   | Minimum | Maximum | Units |
|----------|---|---------|---------|-------|
| $t_{CO}$ | DCLK falling edge to AS_DATA0/ASDO output   | —       | 2       | ns    |
| $t_{SU}$ | Data setup time before falling edge on DCLK | 1.5     | —       | ns    |
| $t_H$    | Data hold time after falling edge on DCLK   | 0       | —       | ns    |

## Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

**Table 56. Remote System Upgrade Circuitry Timing Specifications**

| Parameter                | Minimum | Maximum | Unit |
|--------------------------|---------|---------|------|
| $t_{RU\_nCONFIG}^{(1)}$  | 250     | —       | ns   |
| $t_{RU\_nRSTIMER}^{(2)}$ | 250     | —       | ns   |

**Notes to Table 56:**

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE\_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (2) This is equivalent to strobing the reset\_timer input of the ALTREMOTE\_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

## User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

**Table 57. 12.5-MHz Internal Oscillator Specifications**

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3     | 7.9     | 12.5    | MHz   |

## I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.



You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

## Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

**Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)**

| Parameter<br>(1) | Available<br>Settings | Min<br>Offset<br>(2) | Fast Model |            | Slow Model |       |       |       |       |             |       |      |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
|                  |                       |                      | Industrial | Commercial | C1         | C2    | C3    | C4    | I2    | I3,<br>I3YY | I4    | Unit |
| D1               | 64                    | 0                    | 0.464      | 0.493      | 0.838      | 0.838 | 0.924 | 1.011 | 0.844 | 0.921       | 1.006 | ns   |
| D2               | 32                    | 0                    | 0.230      | 0.244      | 0.415      | 0.415 | 0.459 | 0.503 | 0.417 | 0.456       | 0.500 | ns   |

Table 60. Glossary (Part 2 of 4)

| Letter                | Subject                    | Definitions   |
|-----------------------|----------------------------|---|
| G<br>H<br>I           | —                          | —   |
| J                     | JTAG Timing Specifications | <p>High-speed I/O block—Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p>   |
| K<br>L<br>M<br>N<br>O | —                          | —   |
| P                     | PLL Specifications         | <p><b>Diagram of PLL Specifications <sup>(1)</sup></b></p> <p><b>Note:</b><br/>(1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p> |
| Q                     | —                          | —   |
| R                     | R <sub>L</sub>             | Receiver differential input discrete resistor (external to the Stratix V device).   |

**Table 60. Glossary (Part 4 of 4)**

| Letter   | Subject       | Definitions  |
|----------|---------------|--|
| <b>V</b> | $V_{CM(DC)}$  | DC common mode input voltage.  |
|          | $V_{ICM}$     | Input common mode voltage—The common mode of the differential signal at the receiver.  |
|          | $V_{ID}$      | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.     |
|          | $V_{DIF(AC)}$ | AC differential input voltage—Minimum AC input differential voltage required for switching.  |
|          | $V_{DIF(DC)}$ | DC differential input voltage— Minimum DC input differential voltage required for switching.   |
|          | $V_{IH}$      | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high.  |
|          | $V_{IH(AC)}$  | High-level AC input voltage  |
|          | $V_{IH(DC)}$  | High-level DC input voltage  |
|          | $V_{IL}$      | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low.  |
|          | $V_{IL(AC)}$  | Low-level AC input voltage   |
|          | $V_{IL(DC)}$  | Low-level DC input voltage   |
|          | $V_{OCM}$     | Output common mode voltage—The common mode of the differential signal at the transmitter.  |
|          | $V_{OD}$      | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
|          | $V_{SWING}$   | Differential input voltage   |
|          | $V_X$         | Input differential cross point voltage   |
|          | $V_{OX}$      | Output differential cross point voltage  |
| <b>W</b> | W             | High-speed I/O block—clock boost factor  |
| <b>X</b> | —             | —  |
| <b>Y</b> |               |  |
| <b>Z</b> |               |  |

**Table 61. Document Revision History (Part 2 of 3)**

| Date          | Version | Changes  |
|---------------|---------|--|
| November 2014 | 3.3     | <ul style="list-style-type: none"> <li>■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1.</li> <li>■ Added the I3YY speed grade to the <math>V_{CC}</math> description in Table 6.</li> <li>■ Added the I3YY speed grade to <math>V_{CCHIP\_L}</math>, <math>V_{CCHIP\_R}</math>, <math>V_{CCHSSI\_L}</math>, and <math>V_{CCHSSI\_R}</math> descriptions in Table 7.</li> <li>■ Added 240-<math>\Omega</math> to Table 11.</li> <li>■ Changed CDR PPM tolerance in Table 23.</li> <li>■ Added additional max data rate for fPLL in Table 23.</li> <li>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25.</li> <li>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26.</li> <li>■ Changed CDR PPM tolerance in Table 28.</li> <li>■ Added additional max data rate for fPLL in Table 28.</li> <li>■ Changed the mode descriptions for MLAB and M20K in Table 33.</li> <li>■ Changed the Max value of <math>f_{HCLK\_OUT}</math> for the C2, C2L, I2, I2L speed grades in Table 36.</li> <li>■ Changed the frequency ranges for C1 and C2 in Table 39.</li> <li>■ Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47.</li> <li>■ Added note about nSTATUS to Table 50, Table 51, Table 54.</li> <li>■ Changed the available settings in Table 58.</li> <li>■ Changed the note in “Periphery Performance”.</li> <li>■ Updated the “I/O Standard Specifications” section.</li> <li>■ Updated the “Raw Binary File Size” section.</li> <li>■ Updated the receiver voltage input range in Table 22.</li> <li>■ Updated the max frequency for the LVDS clock network in Table 36.</li> <li>■ Updated the DCLK note to Figure 11.</li> <li>■ Updated Table 23 <math>VO_{CM}</math> (DC Coupled) condition.</li> <li>■ Updated Table 6 and Table 7.</li> <li>■ Added the DCLK specification to Table 55.</li> <li>■ Updated the notes for Table 47.</li> <li>■ Updated the list of parameters for Table 56.</li> </ul> |
| November 2013 | 3.2     | ■ Updated Table 28   |
| November 2013 | 3.1     | ■ Updated Table 33   |
| November 2013 | 3.0     | ■ Updated Table 23 and Table 28  |
| October 2013  | 2.9     | ■ Updated the “Transceiver Characterization” section   |
| October 2013  | 2.8     | <ul style="list-style-type: none"> <li>■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59</li> <li>■ Added Figure 1 and Figure 3</li> <li>■ Added the “Transceiver Characterization” section</li> <li>■ Removed all “Preliminary” designations.</li> </ul>  |